



CE

# **Universal AC Input Module**

#### **Features & Benefits**

- Universal input (85 264V<sub>AC</sub>, 47 63Hz)
- · Chassis-mount or PCB-mount form factor
- Small robust package
- Low profile
- EMI filtering
- Meets EN61000-4-5 Class 3 surge protection when used with external MOV and fuse, paired with Vicor PFM4414 products

## **Typical Applications**

- Small cell base stations
- Telecom switching equipment
- LED lighting
- Test and Measurement Equipment
- 200 400W Industrial Power Systems
- Office Equipment

Product Ratings				
$V_{IN} = 85 - 264V$	$P_{OUT} = up to 450W$			
V <sub>OUT</sub> = Rectified AC	I <sub>OUT</sub> = 5.3A			

## **Product Description**

The AIM in a VIA Package (AC Input Module) is a front-end module designed to interface directly with worldwide AC mains and provide a rectified AC input to the Vicor family of PFM4414 VIA products. The AIM combines a bridge rectifier, EMI filter and surge protection circuitry in an easy-to-use VIA plastic housing. The AIM and PFM components in a VIA Package can realize a small, efficient and simple AC-DC solution for a broad range of end applications.

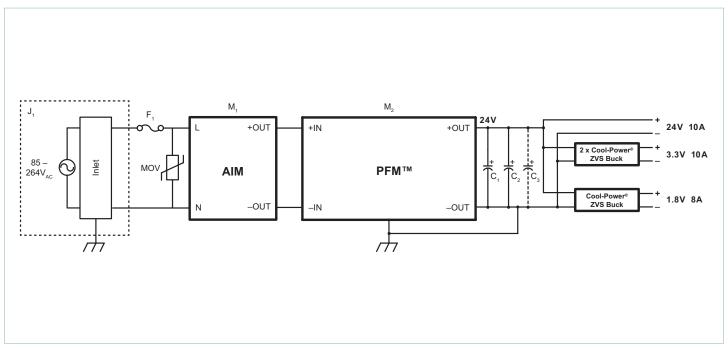


## **Part Ordering Information**

Product Function	Package Length	Package Width	Package Type	Input Voltage	Range Ratio	Output Voltage (Range)	Max Output Power	Product Grade	Optio	n Field
AIM	17	14	Х	В6	М	C7	D5	у	Z	Z
AIM = AC Input Module	Length in Inches x 10	Width in Inches x 10	<b>B</b> = Board VIA <b>V</b> = Chassis VIA	Internal Reference		<b>C</b> = -20 to 100°C <b>T</b> = -40 to 100°C	<b>04</b> = Short P	s/Always On in/Always On in/Always On		



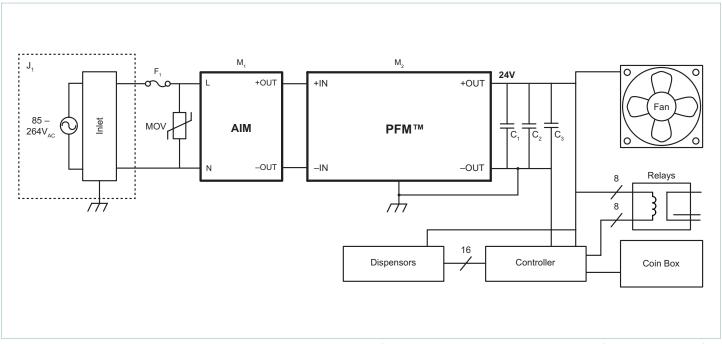
# **Typical PCB Mount Applications**



The PCB terminal option allows mounting on an industry standard printed circuit board, with two different pin lengths.

Parts List for Typical PCB Mount Applications		
J1	Qualtek 703W IEC 320-C14 Power Inlet	
F1	Littelfuse 0216008.MXP 8A 250V <sub>AC</sub> 5 x 20mm holder	
M1	Vicor AIM™ AIM1714BB6MC7D5yzz	
M2	Vicor PFM™ PFM4414BB6M24D0yzz or Vicor PFM PFM4414BB6M48D0yzz	
C1, C2, (C3)	Select capacitors based on 4414 VIA PFM model used, as per typical application parts list.	
MOV	Littelfuse TMOV20RP300E VARISTOR 10kA 30V 250 J 20mm	

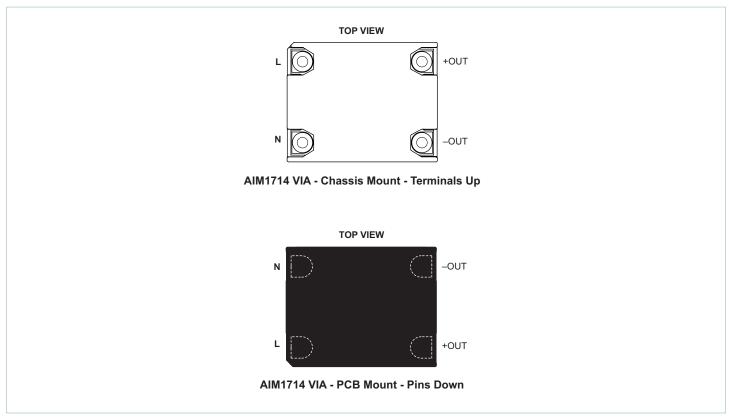
## **Typical Chassis Mount Applications**



The AIM and PFM are available in chassis-mount option, saving the cost of a PCB and allowing access to both sides of the power supply for cooling. The parts list below minimizes the number of interconnects required between necessary components, and selects components with terminals traditionally used for point-to-point chassis wiring.

Parts List for Typical Chassis Mount Applications			
J1	Qualtek 719W or 723W IEC 320-C14 Power Inlet		
F1	<b>Littelfuse</b> 0216008.MXP 8A 250V <sub>AC</sub> 5 x 20mm in a J1, or separate fuse holder		
M1	Vicor AIM™ AIM1714VB6MC7D5y00		
M2	Vicor PFM™ PFM4414VB6M24D0y00 or		
	Vicor PFM PFM4414VB6M48D0y00		
C1, C2, C3	Select capacitors based on PFM4414 VIA model used, as per typical application parts list.		
MOV	Littelfuse TMOV20RP300E VARISTOR 10kA 300V 250 J 20mm		

# **Pin Configuration**



Please note that these pin drawings are not to scale.

# **Pin Descriptions**

Signal Name	Туре	Function
N	INPUT POWER RETURN	AC Neutral / Line 2 input
L	INPUT POWER	AC Line 1 input
-OUT	OUTPUT POWER RETURN	Negative output power terminal
+OUT	OUTPUT POWER	Positive output power terminal

## **Absolute Maximum Ratings**

The absolute maximum ratings below are stress ratings only. Operation at or beyond these maximum ratings can cause permanent damage to the device.

Parameter	Comments	Min	Max	Unit
Peak Voltage at Input Terminals, 1ms Max		0	600	$V_{PK}$
Input Voltage (AC RMS) Continuous		0	275	$V_{RMS}$
Output Current (Continuous)		0	5.3	A <sub>RMS</sub>
Operating Internal Temperature		-40	125	°C
Storage Temperature		<b>–</b> 65	125	°C
Input / Output Pin Torque and Mounting Torque			4 [0.45]	in·lbs [N·m]

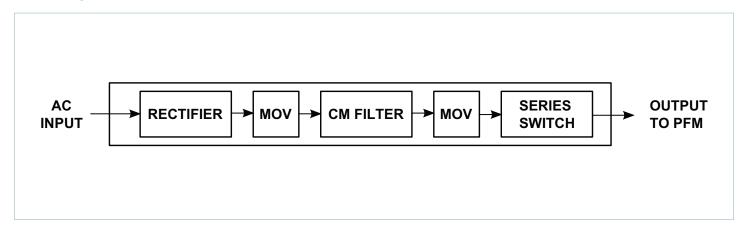
# **Electrical Specifications**

Specifications apply over all line and load conditions, 50Hz and 60Hz line frequencies,  $T_C = 25$ °C, unless otherwise noted. **Boldface** specifications apply over the temperature range of the specified product grade.

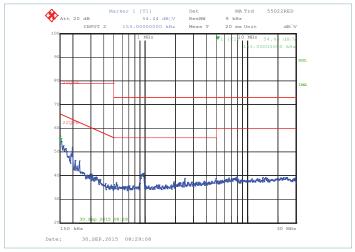
Attribute	Symbol	Conditions / Notes	Min	Тур	Max	Unit
		Input Specification				
Input Voltage Range, Continuous Operation	V <sub>IN</sub>		85		264	$V_{RMS}$
Input Voltage Range, Transient, Non-Operational (Peak), 30s Minimum Interval	V <sub>IN</sub>				600	V
Source Line Frequency Range	f <sub>line</sub>		47		63	Hz
Power Factor	PF	Please see PFM in VIA package datasheet for power factor.				-
Output Specification						
Output Power	P <sub>OUT</sub>				450	W
Output Current (Continuous)	I <sub>OUT</sub>				5.3	А



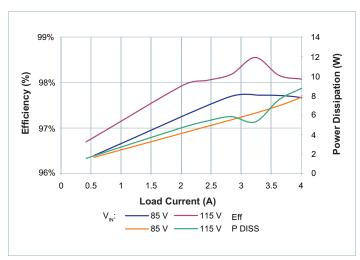
## **Block Diagram**



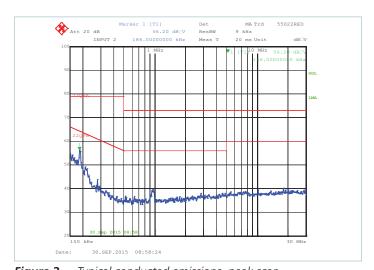
## **Application Characteristics**



**Figure 1** — Typical conducted emissions, peak scan, with PFM4414 VIA, 115V, 90% load with PFM – OUT connected to GND



**Figure 3** —  $V_{IN}$  to  $V_{OUT}$  efficiency and power dissipation vs.  $V_{IN}$  and  $I_{OUT}$ ,  $T_{CASE} = 20^{\circ}\text{C}$ 



**Figure 2** — Typical conducted emissions, peak scan, with PFM4414 VIA, 230V, 90% load with PFM –OUT connected to GND

## **General Characteristics**

Specifications apply over all line and load conditions, 50Hz and 60Hz line frequencies,  $T_C = 25^{\circ}C$ , unless otherwise noted. **Boldface** specifications apply over the temperature range of the specified Product Grade.

Attribute	Symbol	Conditions / Notes	Min	Тур	Max	Unit
		Mashanial				
Longth		Mechanical		44.6 [1.76]		lail man
Length Width	L W			44.6 [1.76]		mm [in]
				35.5 [1.40]		mm [in]
Height Volume	H Vol	Without heatsink		9.3 [0.37] 14.5 [0.88]		mm [in] cm³ [in³]
		without neatsink				
Mass (Weight)	M	C145 seepen helf head		35 [1.2]		g [oz]
Pin Material		C145 copper, half hard	F0		100	
Underplate		Low-stress ductile nickel	50		100	μin
Pin Finish		Palladium	0.8		6	μin
		Soft Gold	0.12		2	μin
		Thermal				
		C-Grade	-20		100	°C
Operating Case Temperature	T <sub>C</sub>	T-Grade	-40		100	°C
Thermal Resistance, Internal to Case Non-Pin Side	$\theta_{\text{INT\_NON\_PIN\_SIDE}}$	Estimated thermal resistance to maximum temperature internal component from isothermal non-pin/non-terminal housing		2.2		°C/W
Thermal Design		See Thermal Considerations on Page 10				
		Soldering				
Temperature		See: AN:401 PCB Mount VIA Soldering Guidelines				
		Reliability				
		MIL-HDBK-217FN2 Parts Count - 25°C Ground Benign, Stationary, Indoors / Computer		8.2		
MTBF		Telcordia Issue 2 - Method I Case III; 25°C		28.6		MHrs
		MIL-HDBK-217FN2 - 25°C Ground Benign, Stationary, Indoors / Computer		7.4		
		Safety				
Agency Approvals / Standards		EN60950-1; CE marked for low voltage dir	ective and Ro	HS recast directive	, as applicabl	е
Dielectric Withstand (Hipot)		IN / OUT to Case	1500			V <sub>AC</sub>
Leakage Current / Touch Current		No Y capacitor connection of GND connection within package		Negligible		
ECC D 4 E		EMI/EMC Compliance				
FCC Part 15, EN55022, CISPR22: 2006 + A1: 2007, Conducted Emissions		Class B Limits - with PFM4414 VIA –OUT connected to GND				
EN61000-4-5: 2006, Surge Immunity		Level 3, Immunity Criteria A with PFM in a VIA Package with external TMOV and fuse, shown on page 2 or 3, required.				



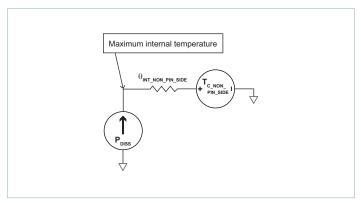
# **Environmental Qualification**

Testing Activity	Reference Standard	Test Details
High Temperature Operating Bias/Life (HTOB/HTOL)	JESD22-A108D	1000hrs. Nominal Full Load at Max operating temperature
Temperature Cycling Test (TCT)	IPC-9592B	125°C to -40°C, 700 cycles
Temperature Humidity Bias (THB)	JESD22-A101C	1000hrs. Nominal Input voltage, Minimal load 85°C, 85% RH
High Temperature Storage (HTS)	JESD22-A103D	1000hrs. 125°C
Low Temperature Storage (LTS)	JESD22-A119	1000hrs. –65°C
Random Vibration	MIL-STD-810G	Method 514.6, Procedure I, Category 24, 20-2000Hz, @7.7g <sub>RMS</sub> , 1hour /axis for 3 axis. Product mounted on an evaluation board, nominal line 50% load.
Mechanical Shock	MIL-STD-810G	Method 516.5, Procedure I, Functional shock 40G, total of 18 shocks. Product mounted on an evaluation board, nominal Line 50% load.
Highly Accelerated Life Test (HALT)	Internal Vicor Procedure - DP-0265	Low and high temperature tests, rapid thermal cycling, random vibration testing, combined stress testing and destruct testing.
Res. Solvents	MIL-STD-202G	Method 215K, 3 minutes exposure
ESD Human Body Model	JEDEC JS-001-2012	Class 1C (HBM) Minimum
ESD Charged Device Model	JESD22-C101E	Class II (CDM) Minimum



#### **Thermal Considerations**

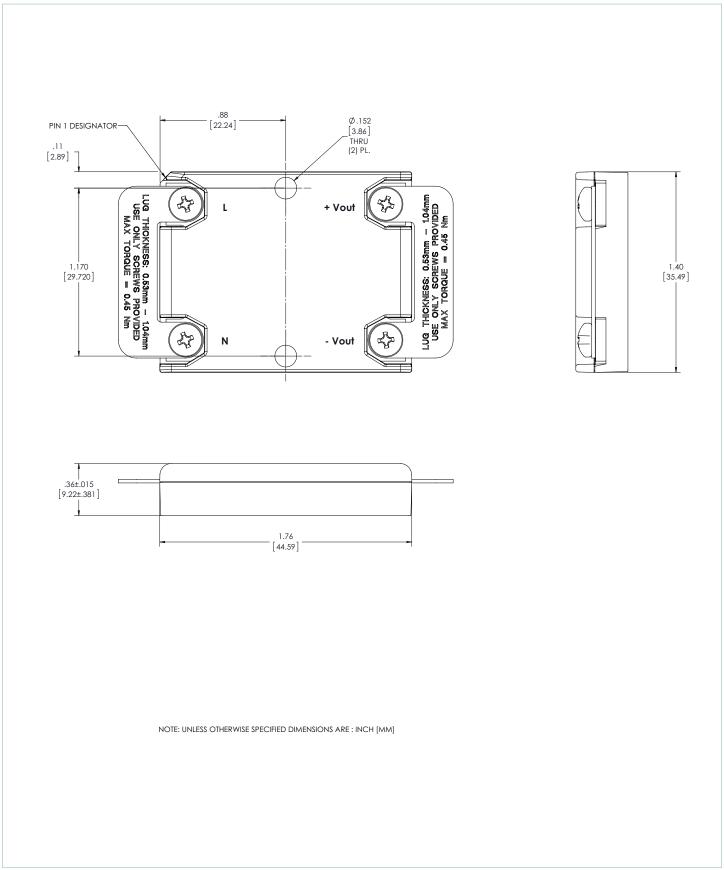
The AIM in a VIA package can be cooled using single-side cooling from the non-pin side. Since the AIM has a maximum internal temperature rating, it is necessary to estimate this internal temperature based on a system-level thermal solution. To this purpose, it is helpful to simplify the thermal solution into a roughly equivalent circuit where power dissipation is modeled as a current source, isothermal surface temperatures are represented as voltages sources, and thermal resistances are represented as resistors. Figure 4 shows the non-pin-side cooling "thermal circuit" for the AIM in VIA package:



**Figure 4** — Single-side cooling thermal model

The internal power dissipation is  $P_{DISS}$ ,  $\theta_{INT\_NON\_PIN\_SIDE}$  is the thermal resistance characteristic of the VIA package and the non-pin-side surface temperature is represented as  $T_{C\_NON\_PIN\_SIDE}$ . The AIM is best attached to a material with high thermal conductivity (e.g., aluminum or copper) to maintain temperature uniformity across the non-pin side.

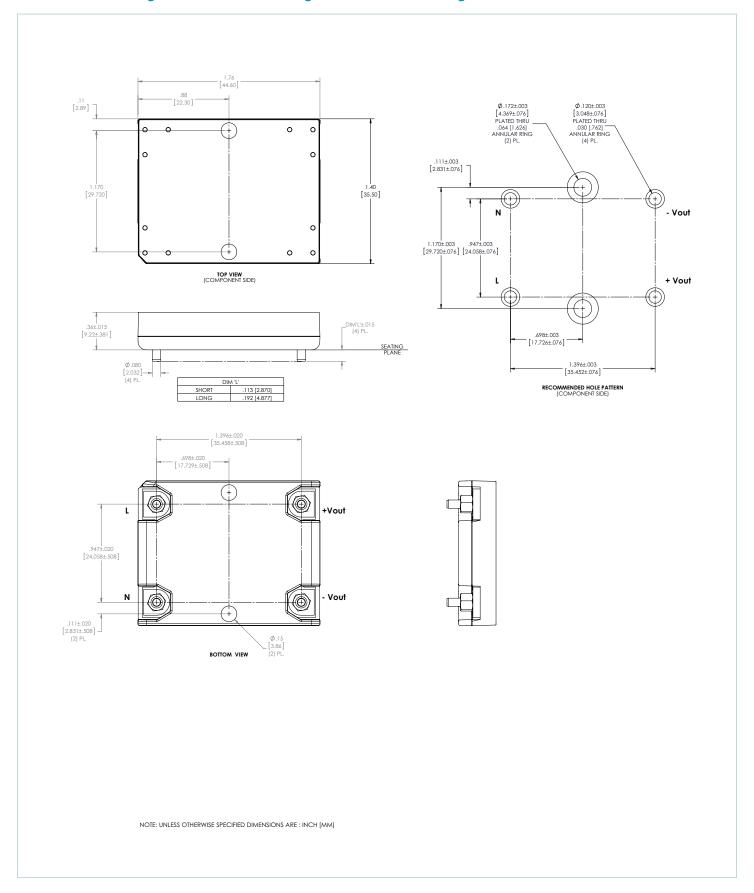
## AIM in a VIA Package Chassis-Mount Package Mechanical Drawing



Product outline drawing; product outline drawings are available in .pdf and .dxf formats. 3D mechanical models are available in .pdf and .step formats.



# AIM in a VIA Package Board-Mount Package Mechanical Drawing



# **Revision History**

Revision	Date	Description	Page Number(s)
1.0	12/24/15	Intitial release	n/a
1.1	07/21/16	Updated dimensions Added "Mass" attribute and soldering temperature note Revised mechanical drawing to show correct PCB pin diameter	1 & 8 8 12
1.2	08/02/17	Removed specific bulk caps in typical application circuit so force user to refer to 24V or 48V PFM specific documentation.  Revised min storage temp to –65C.  Added note stating no touch current in safety table and added fuse to note under surge in compliance table Clarified which side is the bottom in thermal section	2 – 3 4 8 10
1.3	09/27/18	Updated mechanical drawings	11, 12



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